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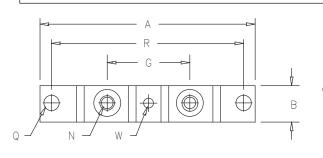
Microsemi Power Products CPT400100

For any questions, you can email us directly: sales@integrated-circuit.com



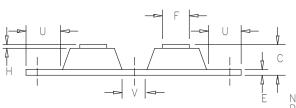
Datasheet of CPT400100 - DIODE MODULE 100V 200A 2TOWER Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

Schottky PowerMod









Common Cathode Baseplate D=Doubler

Baseplate: Nickel plated copper

| Dim. Inches | | Millimeters | | |
|---|---------|-------------------------------------|-------|----------------|
| Min. | Max. | Min. | Max. | Notes |
| B 0.700 C E 0.120 F 0.490 G 1.375 | 0.510 | 17.78 3.05 12.45 34.92 | 12.95 | |
| H 0.010 N Q 0.275 R 3.150 U 0.600 V 0.312 W 0.180 | BSC | 6.99 80.0° 15.24 7.92 | | 1/4-20 Dia. |

| | Microsemi Catalog Number | Industry Part Number | Working Peak Reverse Voltage | Repetitive Peak Reverse Voltage |
|--|-----------------------------|-------------------------|---------------------------------|------------------------------------|
| | CPT40080* | 403CNQ080 MBR40080CT | 80V | 80V |
| | CPT40090* | WENTOGGGGT | 90V | 90V |
| CPT400100* 403CNQ100 MBRP400100CTL MBR400100CT | | 100V | 100V | |
| | *Add Sut | ffix A for Comm | non Anode, D for | Doubler |

- Schottky Barrier Rectifier
- Guard Ring Protection
- 400 Amperes/80-100 Volts
- 175°C Junction Temperature
- Reverse Energy Tested
- ROHS Compliant

Electrical Characteristics

F(AV) 400 Amps Average forward current per pkg F(AV) 200 Amps Average forward current per leg Maximum surge current per leg FSM 3000 Amps Maximum repetitive reverse current per leg |R(OV) 2 Amps Max peak forward voltage per leg VFM .89 Volts .89 Volts Max peak forward voltage per leg V_{FM} .69 Volts Max peak forward voltage per leg ^IRM 50 mA Max peak reverse current per leg ^IRM 5.0 mA Max peak reverse current per leg Typical junction capacitance per leg 4400 pF

 ^{T}C = 121°C, Square wave, $^{R}\Theta JC$ = 0.16°C/W ^{T}C = 121°C, Square wave, $^{R}\Theta JC$ = 0.32°C/W 8.3ms, half sine, $^{\mathsf{T}}\mathsf{J}=175^{\circ}\mathsf{C}$ f = 1 KHZ, 25°C, 1 μ sec square wave IFM = 200A:TJ = 25°C*|FM| = 200A:TJ = 175°C*

VRRM, TJ = 125°C* VRRM, TJ = 25°C $V_{R} = 5.0 V.^{T}C = 25^{\circ}C$

*Pulse test: Pulse width 300 µsec, Duty cycle 2%

Thermal and Mechanical Characteristics

TSTG Storage temp range -55°C to 175°C ΤJ Operating junction temp range -55°C to 175°C R OJC 0.32°C/W 0.16°C/W Max thermal resistance per leg Junction to case Rejc Max thermal resistance per pkg Junction to case Recs 0.08°C/W Case to sink Typical thermal resistance (greased) 35-40 inch pounds Terminal Torque Mounting Base Torque (outside holes) Mounting Base Torque (center hole) 30-40 inch pounds 8-10 inch pounds center hole must be torqued first Weight 2.8 ounces (77 grams) typical





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CPT40080-CPT400100

Figure 1 Typical Forward Characteristics — Per Leg

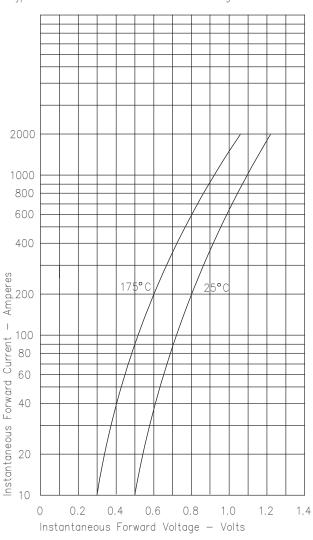


Figure 3 Typical Junction Capacitance - Per Leg 100,000 60,000 40,000 20,000 Junction Capacitance 10,000 6000 4000 2000 1000 0.1 0.5 1.0 5.0 10 50 100 Reverse Voltage - Volts

Forward Current Derating — Per Leg 0| Temperature 165 155 Allowable Case 145 135 125 Maximum 115 105 60 120 180 240 300 Average Forward Current - Amperes

Figure 2 Typical Reverse Characteristics — Per Leg

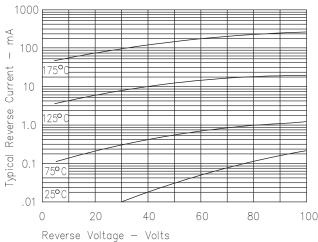
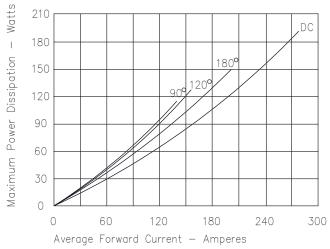


Figure 5
Maximum Forward Power Dissipation — Per Leg







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